

# 700 mA Dual H-Bridge Motor Driver with 3.0 V Compatible Logic I/O

The 17531A is a monolithic dual H-Bridge power IC ideal for portable electronic applications containing bipolar step motors and/or brush DC motors (e.g., cameras and disk drive head positioners).

The 17531A operates from 2.0 to 8.6 V using the internal charge pump, with independent control of each H-Bridge, via a parallel MCU interface. The device features built-in shoot-through current protection and an undervoltage shutdown function.

The 17531A has four operating modes: Forward, Reverse, Brake, and Tri-state (high-impedance). The 17531A has a low total  $R_{DS(ON)}$  of  $1.2\ \Omega$  (max @  $25\ ^\circ\text{C}$ ).

The 17531A efficiently drives many types of micromotors with low power dissipation owing to its low output resistance and high output slew rates. The H-Bridge outputs can be independently pulse width modulated (PWM'ed) at up to 200 kHz for speed/torque and current control.

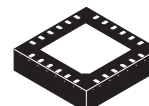
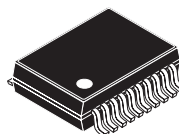
This device is powered by SMARTMOS technology.

## Features

- Low total  $R_{DS(ON)}$   $0.8\ \Omega$  (Typ),  $1.2\ \Omega$  (Max) @  $25\ ^\circ\text{C}$
- Output current 0.7 A (DC)
- Shoot-through current protection circuit
- PWM control input frequency up to 200 kHz
- Built-in charge pump circuit
- Low power consumption
- Undervoltage detection and shutdown circuit
- Power save mode with current draw  $\leq 2.0\ \mu\text{A}$

**17531A**

**DUAL H-BRIDGE**



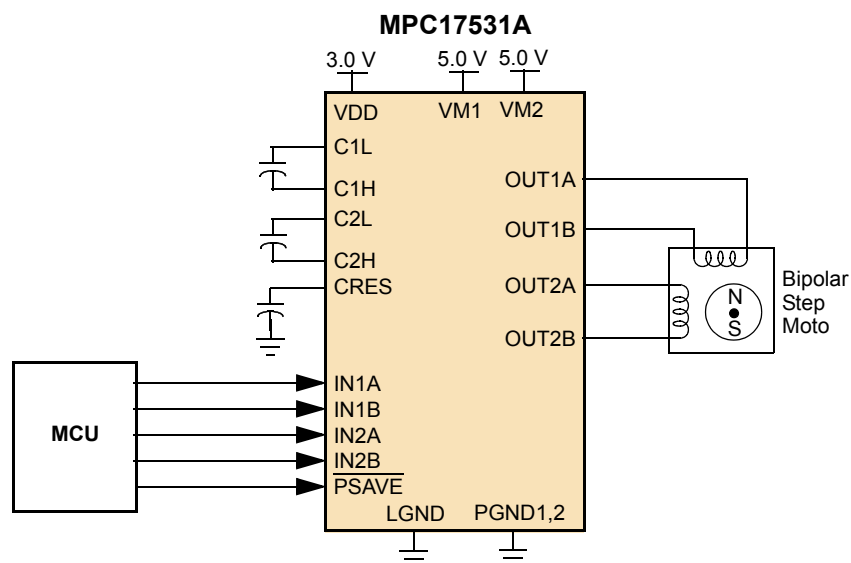
Bottom View

**EV SUFFIX (PB-FREE)**  
**98ASA10616D**  
**20-PIN VMFP**

**EP SUFFIX (PB-FREE)**  
**98ARL10577D**  
**24-PIN QFN**

## ORDERING INFORMATION

Device (for tape and reel, add an R2 suffix)	Temperature Range ( $T_A$ )	Package
MPC17531ATEP	-20 to $65\ ^\circ\text{C}$	20 QFN
MPC17531ATEV/EL		24 VMFP



**Figure 1. 17531A Simplified Application Diagram**

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## INTERNAL BLOCK DIAGRAM

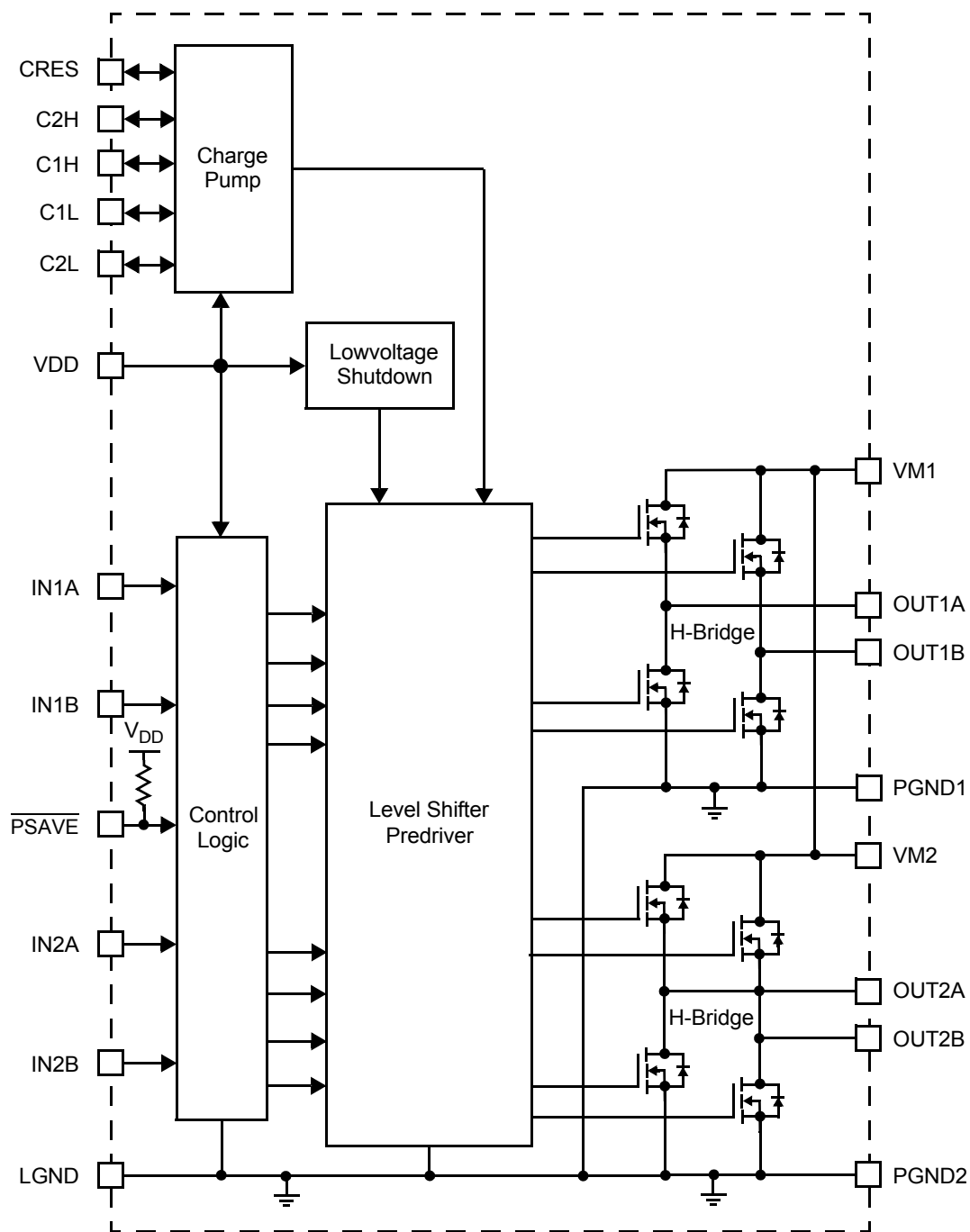


Figure 2. 17531A Simplified Internal Block Diagram

## PIN CONNECTIONS

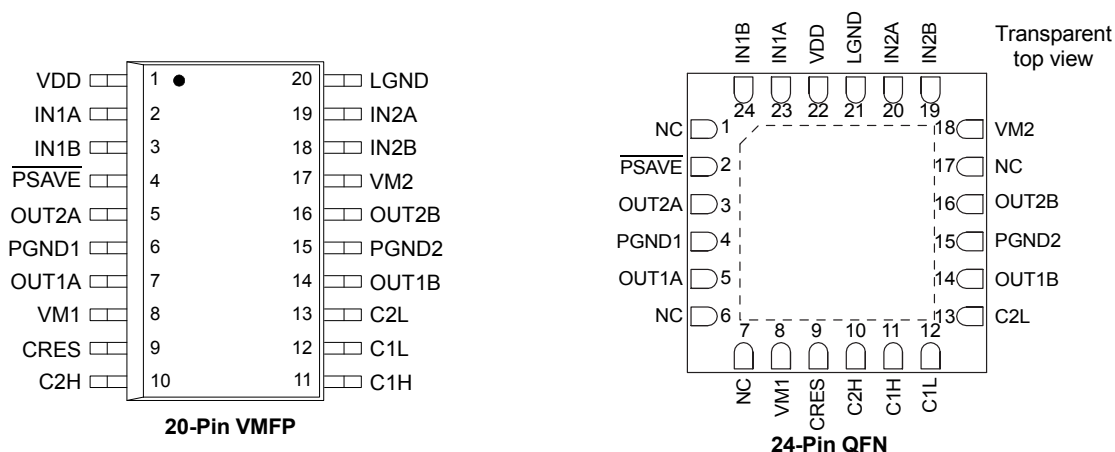


Figure 3. Pin Connections

A functional description of each pin can be found in the Functional Pin Description section beginning on [page 9](#).

Table 1. 17531A, 20-Pin VMFP Definitions

Pin Number 20-Pin VMFP	Pin Number 24-Pin QFN	Pin Name	Formal Name	Definition
1	22	VDD	Logic Supply	Control circuit power supply pin.
2	23	IN1A	Logic Input Control 1A	Logic input control of OUT1A (refer to <a href="#">Table 5, Truth Table</a> , page 8).
3	24	IN1B	Logic Input Control 1B	Logic input control of OUT1B (refer to <a href="#">Table 5, Truth Table</a> , page 8).
4	2	PSAVE	Power Save	Logic input controlling power save mode.
5	3	OUT2A	H-Bridge Output 2A	Output A of H-Bridge channel 2.
6	4	PGND1	Power Ground 1	High-current power ground 1.
7	5	OUT1A	H-Bridge Output 1A	Output A of H-Bridge channel 1.
8	8	VM1	Motor Drive Power Supply 1	Positive power source connection for H-Bridge 1 (Motor Drive Power Supply).
9	9	CRES	Predriver Power Supply	Internal triple charge pump output as predriver power supply.
10	10	C2H	Charge Pump 2H	Charge pump bucket capacitor 2 (positive pole).
11	11	C1H	Charge Pump 1H	Charge pump bucket capacitor 1 (positive pole).
12	12	C1L	Charge Pump 1L	Charge pump bucket capacitor 1 (negative pole).
13	13	C2L	Charge Pump 2L	Charge pump bucket capacitor 2 (negative pole).
14	14	OUT1B	H-Bridge Output 1B	Output B of H-Bridge channel 1.
15	15	PGND2	Power Ground 2	High-current power ground 2.
16	16	OUT2B	H-Bridge Output 2B	Output B of H-Bridge channel 2.
17	17	VM2	Motor Drive Power Supply 2	Positive power source connection for H-Bridge 2 (Motor Drive Power Supply).
18	19	IN2B	Logic Input Control 2B	Logic input control of OUT2B (refer to <a href="#">Table 5, Truth Table</a> , page 8).
19	20	IN2A	Logic Input Control 2A	Logic input control of OUT2A (refer to <a href="#">Table 5, Truth Table</a> , page 8).
20	21	LGND	Logic Ground	Low-current logic signal ground.
N/A	1, 6, 7, 17	NC	—	No Connect

## ELECTRICAL CHARACTERISTICS

## MAXIMUM RATINGS

**Table 2. Maximum Ratings**

All voltages are with respect to ground, unless otherwise noted. Exceeding these ratings may cause a malfunction or permanent damage to the device.

Ratings	Symbol	Value	Unit
Motor Supply Voltage	$V_M$	-0.5 to 11.0	V
Charge Pump Output Voltage	$V_{CRES}$	-0.5 to 14.0	V
Logic Supply Voltage	$V_{DD}$	-0.5 to 5.0	V
Signal Input Voltage	$V_{IN}$	-0.5 to $V_{DD}+0.5$	V
Driver Output Current	$I_O$ $I_{OPK}$	0.7 1.4	A
Continuous			
Peak <sup>(1)</sup>			
ESD Voltage <sup>(2)</sup>	$V_{ESD1}$ $V_{ESD2}$	$\pm 1200$ $\pm 150$	V
Human Body Model			
Machine Model			
Operating Junction Temperature	$T_J$	-20 to 150	°C
Operating Ambient Temperature	$T_A$	-20 to 65	°C
Storage Temperature Range	$T_{STG}$	-65 to 150	°C
Thermal Resistance <sup>(3)</sup>	$R_{\theta JA}$	50	°C/W
Power Dissipation <sup>(4)</sup>	$P_D$	1.0 2.5	W
WMFP			
QFN			
Pin Soldering Temperature <sup>(5)</sup>	$T_{SOLDER}$	260	°C
Peak Package Reflow Temperature During Reflow <sup>(5), (6)</sup>	$T_{PPRT}$	Note 6	°C

## Notes

- $T_A = 25\text{ °C}$ , 10 ms pulse width at 200 ms intervals.
- ESD1 testing is performed in accordance with the Human Body Model ( $C_{ZAP} = 100\text{ pF}$ ,  $R_{ZAP} = 1500\text{ }\Omega$ ), ESD2 testing is performed in accordance with the Machine Model ( $C_{ZAP} = 200\text{ pF}$ ,  $R_{ZAP} = 0\text{ }\Omega$ ).
- QFN24: 45 x 30 x 1 [mm] glass EPOXY board mount. (See: recommended heat pattern) VMFP16: 37 x 50 x 1.6 [mm] glass EPOXY board mount. When the exposed pad is bonded,  $R_{sj}$  is not performed.
- Maximum at  $T_A = 25\text{ °C}$ . When the exposed pad is bonded,  $R_{sj}$  is not performed.
- Pin soldering temperature limit is for 10 seconds maximum duration. Not designed for immersion soldering. Exceeding these limits may cause malfunction or permanent damage to the device.
- Freescall's Package Reflow capability meets Pb-free requirements for JEDEC standard J-STD-020C. For Peak Package Reflow Temperature and Moisture Sensitivity Levels (MSL), Go to [www.freescale.com](http://www.freescale.com), search by part number [e.g. remove prefixes/suffixes and enter the core ID to view all orderable parts. (i.e. MC33xxxD enter 33xxx), and review parametrics.

## STATIC ELECTRICAL CHARACTERISTICS

**Table 3. Static Electrical Characteristics**

Characteristics noted under conditions  $T_A = 25\text{ }^{\circ}\text{C}$ ,  $V_{DD} = 3.0\text{ V}$ ,  $V_M = 5.0\text{ V}$ ,  $\text{GND} = 0\text{ V}$ , unless otherwise noted. Typical values noted reflect the approximate parameter means at  $T_A = 25\text{ }^{\circ}\text{C}$  under nominal conditions, unless otherwise noted.

Characteristic	Symbol	Min	Typ	Max	Unit
<b>POWER INPUT</b>					
Motor Supply Voltage (Using Internal Charge Pump) <sup>(7)</sup>	$V_{M-CP}$	2.0	5.0	8.6	V
Motor Supply Voltage ( $V_{CRES}$ Applied Externally) <sup>(8)</sup>	$V_{M-NCP}$	–	–	10	V
Gate Drive Voltage - Motor Supply Voltage ( $V_{CRES}$ Applied Externally) <sup>(9)</sup>	$V_{CRES-VM}$	5.0	6.0	–	V
Logic Supply Voltage	$V_{DD}$	2.7	3.0	3.6	V
Driver Quiescent Supply Current					$\mu\text{A}$
No Signal Input	$I_{QM}$	–	–	100	
Power Save Mode	$I_{QM-PSAVE}$	–	–	1.0	
Logic Quiescent Supply Current					mA
No Signal Input <sup>(10)</sup>	$I_{QVDD}$	–	–	1.0	
Power Save Mode	$I_{QVDD-PSAVE}$	–	–	1.0	
Operating Power Supply Current					mA
Logic Supply Current <sup>(11)</sup>	$I_{VDD}$	–	–	3.0	
Charge Pump Circuit Supply Current <sup>(12)</sup>	$I_{CRES}$	–	–	0.7	
Low $V_{DD}$ Detection Voltage <sup>(13)</sup>	$V_{DDDET}$	1.0	1.6	2.5	V
Driver Output ON Resistance <sup>(14)</sup>	$R_{DS(ON)}$	–	0.8	1.2	Ohms
<b>GATE DRIVE</b>					
Gate Drive Voltage <sup>(12)</sup>	$V_{CRES}$				V
No Current Load		12	13	13.5	
Gate Drive Ability (Internally Supplied)	$V_{CRESLOAD}$				V
$I_{CRES} = -1.0\text{ mA}$		8.5	9.2	–	
Recommended External Capacitance (C1L–C1H, C2L–C2H, $C_{RES-GND}$ )	$C_{CP}$	0.01	0.1	1.0	$\mu\text{F}$

**Notes**

- Gate drive voltage  $V_{CRES}$  is generated internally.  $2 \times V_{DD} + V_M$  must be  $< V_{CRES\text{ MAX}}$  (13.5 V).
- No internal charge pump used.  $V_{CRES}$  is applied from an external source.
- $R_{DS(ON)}$  is not guaranteed if  $V_{CRES-VM} < 5.0\text{ V}$ . Also, function is not guaranteed if  $V_{CRES-VM} < 3.0\text{ V}$ .
- $I_{QVDD}$  includes the current to pre-driver circuit.
- $I_{VDD}$  includes the current to predriver circuit at  $f_{IN} = 100\text{ kHz}$ .
- At  $f_{IN} = 20\text{ kHz}$ .
- Detection voltage is defined as when the output becomes high-impedance after  $V_{DD}$  drops below the detection threshold.  $V_{CRES}$  is applied from an external source.  $2 \times V_{DD} + V_M$  must be  $< V_{CRES\text{ MAX}}$  (13.5 V).
- $I_O = 0.7\text{ A}$  source + sink.

**Table 3. Static Electrical Characteristics (continued)**

Characteristics noted under conditions  $T_A = 25\text{ }^{\circ}\text{C}$ ,  $V_{DD} = 3.0\text{ V}$ ,  $V_M = 5.0\text{ V}$ ,  $\text{GND} = 0\text{ V}$ , unless otherwise noted. Typical values noted reflect the approximate parameter means at  $T_A = 25\text{ }^{\circ}\text{C}$  under nominal conditions, unless otherwise noted.

Characteristic	Symbol	Min	Typ	Max	Unit
CONTROL LOGIC					
Logic Input Voltage	$V_{IN}$	0	–	$V_{DD}$	V
Logic Inputs ( $2.7\text{ V} < V_{DD} < 3.3\text{ V}$ )					
High Level Input Voltage	$V_{IH}$	$V_{DD} \times 0.7$	–	–	V
Low Level Input Voltage	$V_{IL}$	–	–	$V_{DD} \times 0.3$	V
High Level Input Current	$I_{IH}$	–	–	1.0	$\mu\text{A}$
Low Level Input Current	$I_{IL}$	–1.0	–	–	$\mu\text{A}$
$\overline{\text{PSAVE}}$ Pin Input Current Low	$I_{IL-\overline{\text{PSAVE}}}$	–	50	100	$\mu\text{A}$

**DYNAMIC ELECTRICAL CHARACTERISTICS****Table 4. Dynamic Electrical Characteristics**

Characteristics noted under conditions  $T_A = 25\text{ }^{\circ}\text{C}$ ,  $V_{DD} = 3.0\text{ V}$ ,  $V_M = 5.0\text{ V}$ ,  $\text{GND} = 0\text{ V}$ , unless otherwise noted. Typical values noted reflect the approximate parameter means at  $T_A = 25\text{ }^{\circ}\text{C}$  under nominal conditions, unless otherwise noted.

Characteristic	Symbol	Min	Typ	Max	Unit
<b>INPUT</b>					
Pulse Input Frequency	$f_{IN}$	–	–	200	kHz
Input Pulse Rise Time <sup>(15)</sup>	$t_R$	–	–	1.0 <sup>(16)</sup>	$\mu\text{s}$
Input Pulse Fall Time <sup>(17)</sup>	$t_F$	–	–	1.0 <sup>(16)</sup>	$\mu\text{s}$
<b>OUTPUT</b>					
Propagation Delay Time <sup>(18)</sup>					$\mu\text{s}$
Turn-ON Time	$t_{PLH}$	–	0.1	0.5	
Turn-OFF Time	$t_{PHL}$	–	0.1	0.5	
Charge Pump Wake-up Time <sup>(19)</sup>	$t_{VGON}$	–	1.0	3.0	ms
Low Voltage Detection Time	$t_{VDDDET}$	–	–	10	ms

**Notes**

15. Time is defined between 10% and 90%.
16. That is, the input waveform slope must be steeper than this.
17. Time is defined between 90% and 10%.
18. Output load is  $8.0\text{ }\Omega$  DC.
19.  $C_{CP} = 0.1\text{ }\mu\text{F}$ .

## TIMING DIAGRAMS

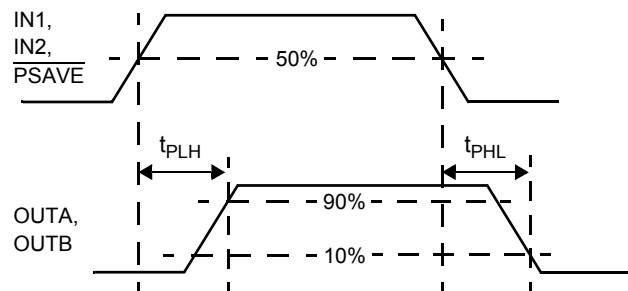


Figure 4.  $t_{PLH}$ ,  $t_{PHL}$ , and  $t_{PZH}$  Timing

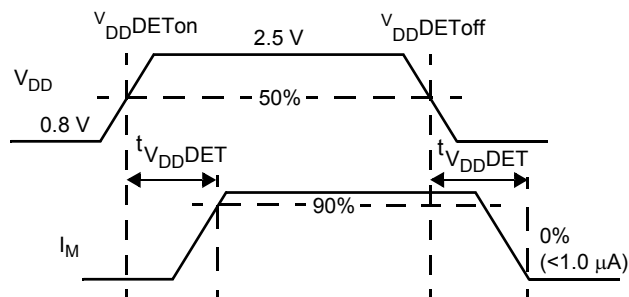


Figure 5. Low Voltage Detection Timing

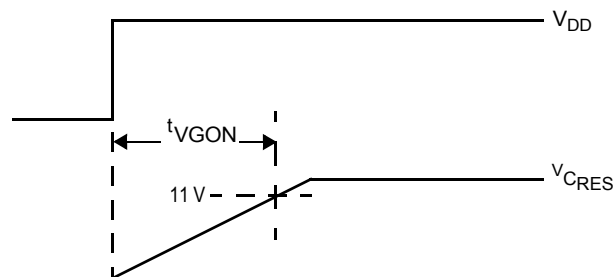


Figure 6. Charge Pump Timing

Table 5. Truth Table

INPUT			OUTPUT		Charge Pump and Low Voltage Detector
PSAVE	IN1A IN2A	IN1B IN2B	OUT1A OUT2A	OUT1B OUT2B	
L	L	L	L	L	RUN
L	H	L	H	L	RUN
L	L	H	L	H	RUN
L	H	H	Z	Z	RUN
H	X	X	Z	Z	STOP

H = High.

L = Low.

Z = High-impedance.

X = Don't care.

PSAVE pin is pulled up to  $V_{DD}$  with internal resistance.

## FUNCTIONAL DESCRIPTION

### INTRODUCTION

The 17531A is a monolithic dual H-Bridge ideal for portable electronic applications to control bipolar step motors and brush DC motors, such as those found in camera lens assemblies, camera shutters, and optical disk drives. The device features an on-board charge pump, as well as built-in shoot-through current protection and under-voltage shutdown.

The 17531A has four operating modes: Forward, Reverse, Brake, and Tri-state (high-impedance). The MOSFETs comprising the output bridge have a total source + sink  $R_{DS(ON)} \leq 1.2 \Omega$ .

The 17531A can simultaneously drive two brush DC motors or one bipolar step motor. The drivers are designed to be PWMed at frequencies up to 200 kHz.

### FUNCTIONAL PIN DESCRIPTION

#### LOGIC SUPPLY (VDD)

The VDD pin carries the logic supply voltage and current into the logic sections of the IC. VDD has an undervoltage threshold. If the supply voltage drops below the undervoltage threshold, the output power stage switches to a tri-state condition. When the supply voltage returns to a level that is above the threshold, the power stage automatically resumes normal operation according to the established condition of the input pins.

#### LOGIC INPUT CONTROL (IN1A, IN1B, IN2A, AND IN2B)

These logic input pins control each H-Bridge output. IN1A logic HIGH = OUT1A HIGH. However, if all inputs are taken HIGH, the outputs bridges are both tri-stated (refer to [Table 5, Truth Table](#), page 8).

#### POWER SAVE (PSAVE)

The PSAVE pin is a HIGH = TRUE power save mode input. When PSAVE = HIGH, all H-Bridge outputs (OUT1A, OUT1B, OUT2A, and OUT2B) are tri-stated (High-Z), regardless of logic inputs (IN1A, IN1B, IN2A, and IN2B) states, and the internal charge pump and low voltage detection current are shut off to save power.

#### H-BRIDGE OUTPUT (OUT1A, OUT1B, OUT2A, AND OUT2B)

These pins provide connection to the outputs of each of the internal H-Bridges (see [Figure 2, 17531A Simplified Internal Block Diagram](#), page 2).

#### MOTOR DRIVE POWER SUPPLY (VM1 AND VM2)

The VM pins carry the main supply voltage and current into the power sections of the IC. This supply then becomes controlled and/or modulated by the IC as it delivers the power to the loads attached between the OUTput pins. All VM pins must be connected together on the printed circuit board.

#### CHARGE PUMP (C1L AND C1H, C2L AND C2H)

These two pairs of pins, the C1L and C1H, and the C2L and C2H, connect to the external bucket capacitors required by the internal charge pump. The typical value for the bucket capacitors is 0.1  $\mu$ F.

#### PREDRIVER POWER SUPPLY (CRES)

The CRES pin is the output of the internal charge pump. Its output voltage is approximately three times of  $V_{DD}$  voltage. The  $V_{CRES}$  voltage is power supply for the internal predriver circuit of H-Bridges.

#### POWER GROUND (PGND)

Power ground pins. They must be tied together on the PCB.

#### LOGIC GROUND (LGND)

Logic ground pin.

## TYPICAL APPLICATIONS

[Figure 7](#) shows a typical application for the 17531A. When applying the gate voltage to the CRES pin from an external source, be sure to connect it via a resistor equal to or greater than  $R_G = V_{CRES}/0.02 \Omega$ .

The internal charge pump of this device is generated from the  $V_{DD}$  supply; therefore, care must be taken to provide sufficient gate-source voltage for the high side MOSFETs when  $V_M \gg V_{DD}$  (e.g.,  $V_M = 5.0 \text{ V}$ ,  $V_{DD} = 3.3 \text{ V}$ ), in order to ensure full enhancement of the high side MOSFET channels.

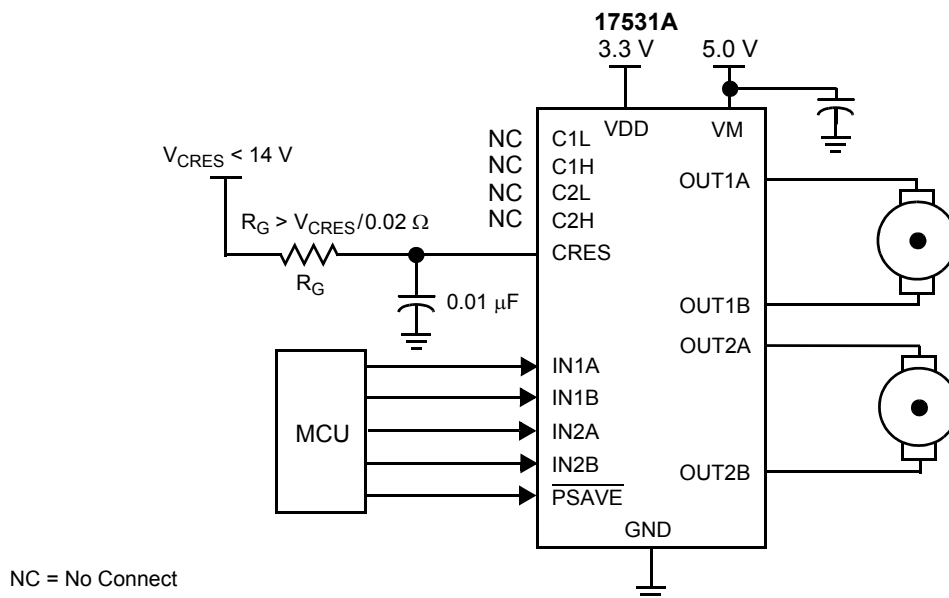


Figure 7. 17531A Typical Application Diagram

### CEMF SNUBBING TECHNIQUES

Care must be taken to protect the IC from potentially damaging CEMF spikes induced when commutating currents in inductive loads. Typical practice is to provide snubbing of voltage transients via placing a capacitor or zener at the supply pin (VM) (see [Figure 8](#)).

### PCB LAYOUT

When designing the printed circuit board (PCB), connect sufficient capacitance between power supply and ground pins to ensure proper filtering from transients. For all high current paths, use wide copper traces and the shortest possible distances.

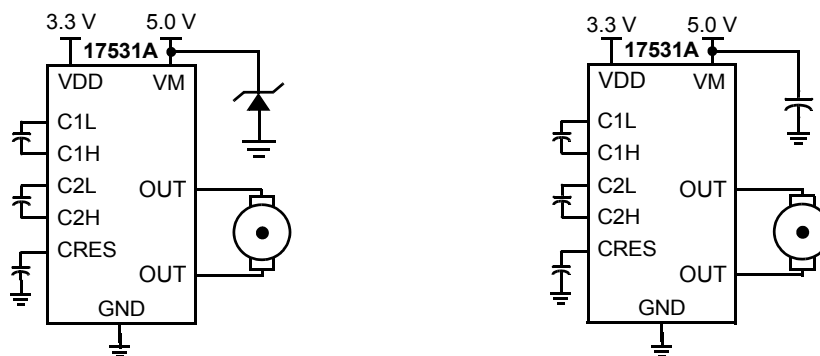
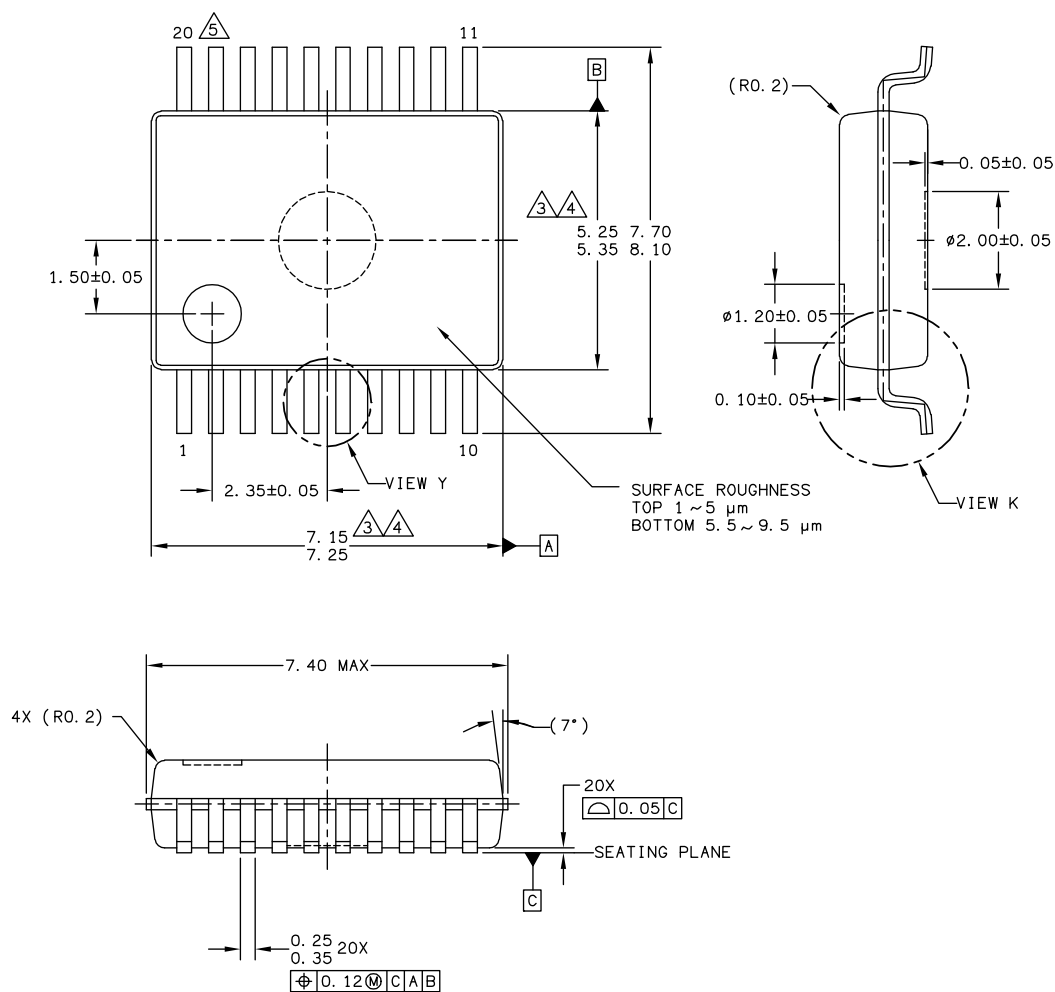


Figure 8. CEMF Snubbing Techniques

# PACKAGING

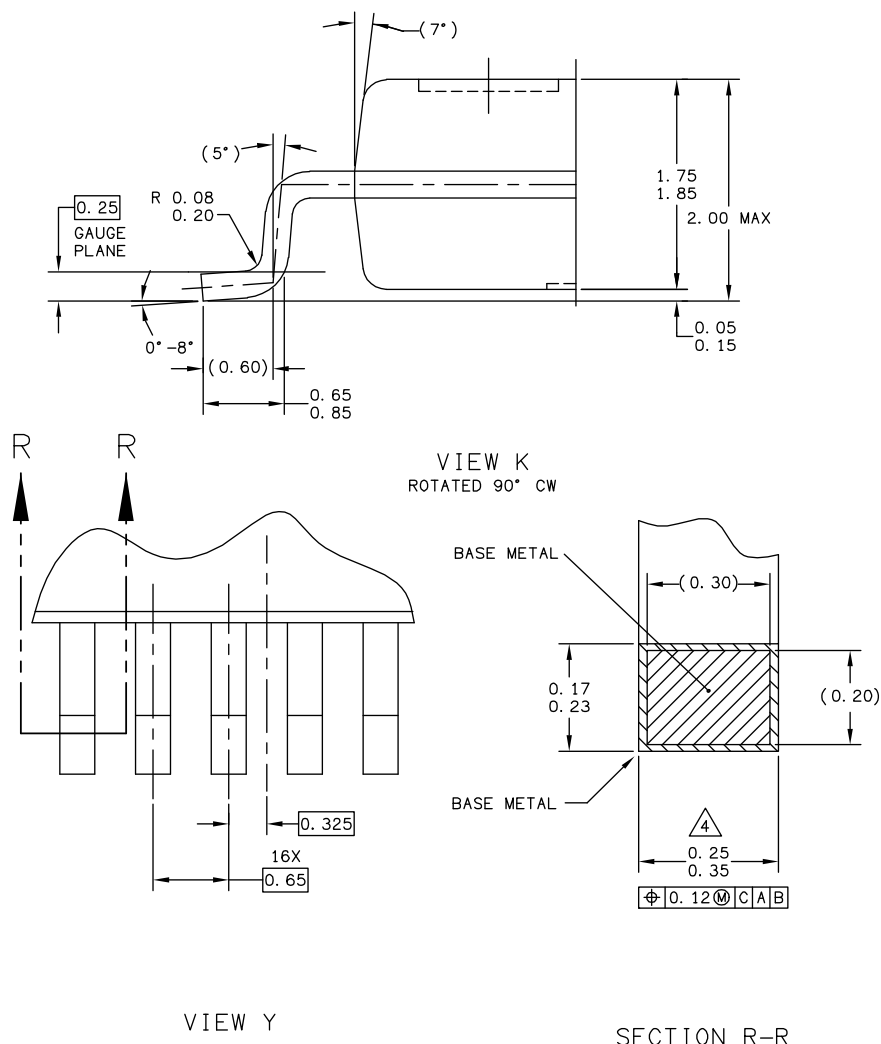
## PACKAGE DIMENSIONS

For the most current package revision, visit [www.freescale.com](http://www.freescale.com) and perform a keyword search using the "98A" drawing number listed .



© FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED.  TITLE: EIAJ VMFP 20LD, 0.65 PITCH	MECHANICAL OUTLINE		PRINT VERSION NOT TO SCALE
	DOCUMENT NO: 98ASA10616D		REV: B
	CASE NUMBER: 1569-02		01 DEC 2006
	STANDARD: NON-JEDEC		

**EV (Pb-FREE) SUFFIX**  
20-LEAD VMFP  
98ASA10616D  
ISSUE B



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	CASE NUMBER: 1569-02		01 DEC 2006
	STANDARD: NON-JEDEC		

**EV (Pb-FREE) SUFFIX**  
20-LEAD VMFP  
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NOTES:

1 DIMENSIONING AND TOLERANCING PER ASME Y14.5M - 1994.

2 ALL DIMENSIONS ARE IN MILLIMETERS.

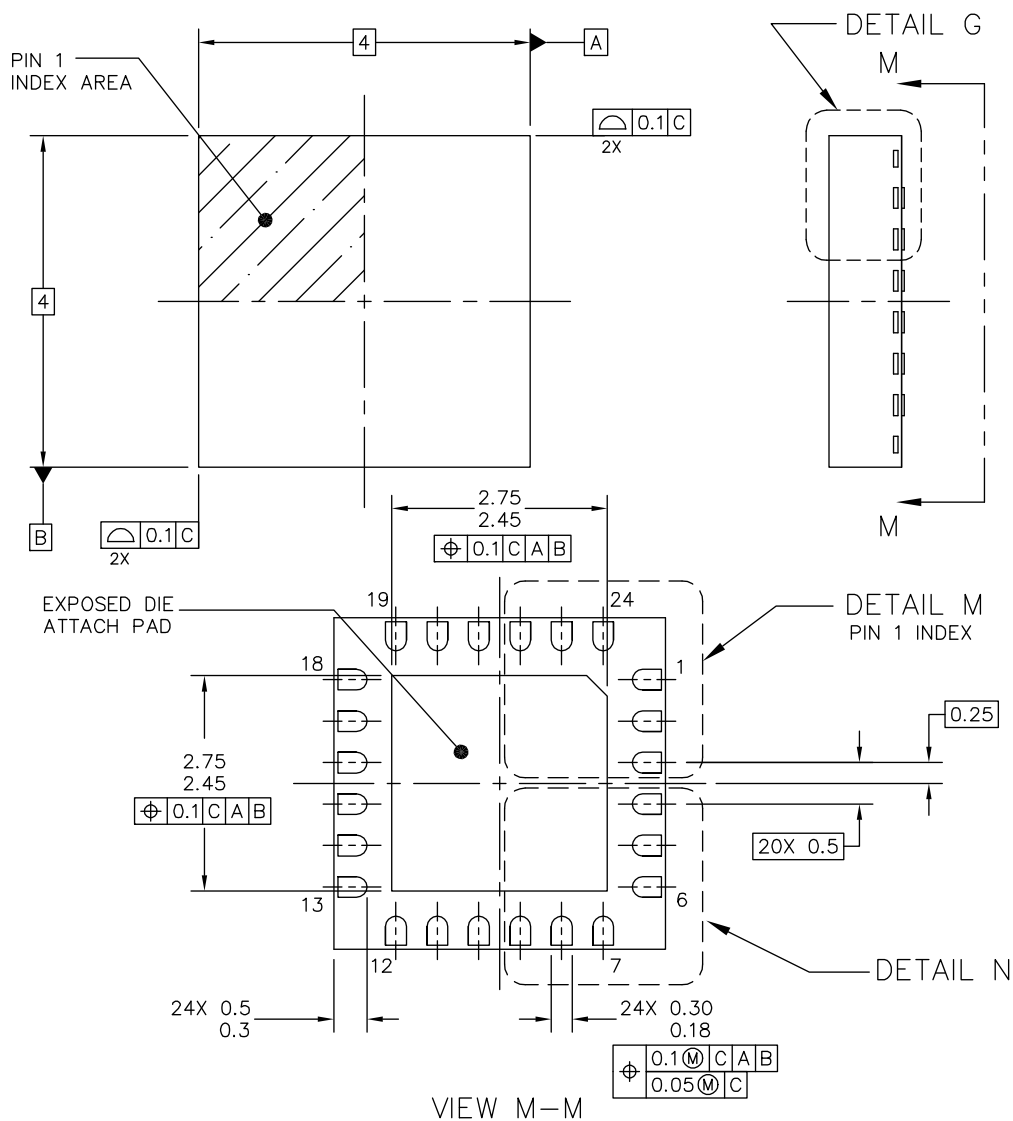
3 DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.  
MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.10 ANY SIDE.  
DIMENSIONS DO NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.  
INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 PER SIDE.

4 DIMENSIONS ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY  
EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS, AND INTERLEAD FLASH,  
BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.

5 TERMINAL NUMBER ARE SHOWN FOR REFERENCE ONLY.

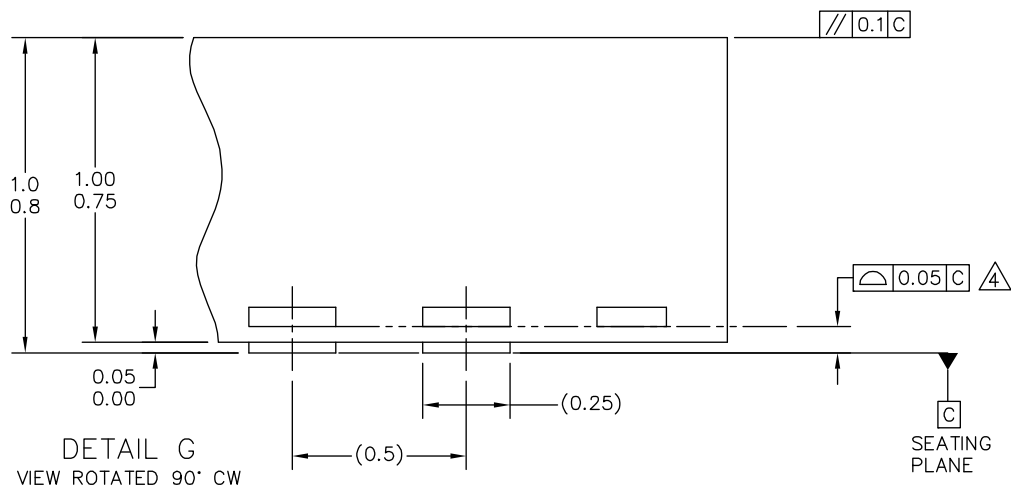
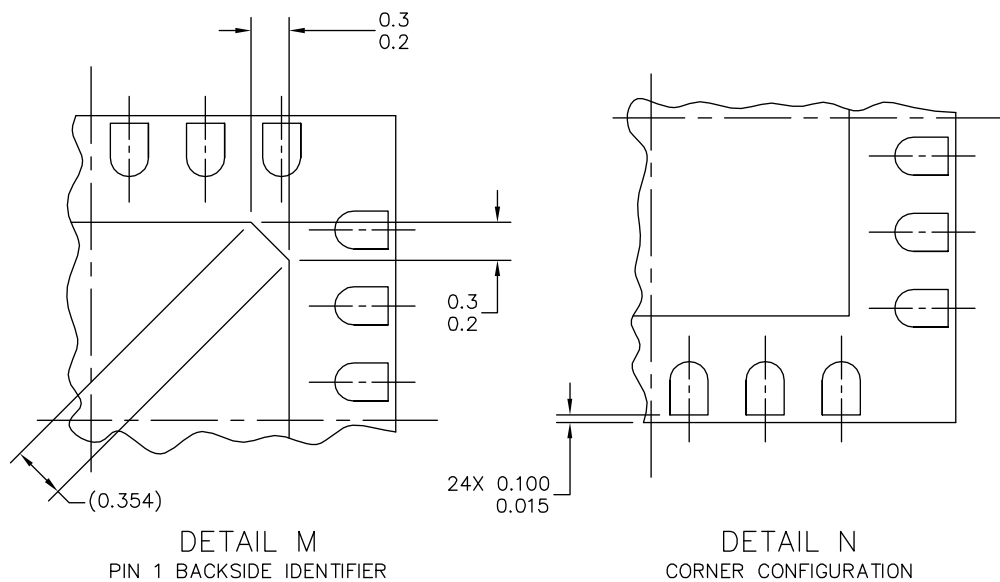
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TITLE:  EIAJ VMFP 20LD, 0.65 PITCH		DOCUMENT NO: 98ASA10616D		REV: B	
		CASE NUMBER: 1569-02		01 DEC 2006	
		STANDARD: NON-JEDEC			

**EV (Pb-FREE) SUFFIX**  
20-LEAD VMFP  
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TITLE: THERMALLY ENHANCED QUAD FLAT NON-LEADED PACKAGE (QFN) 24 TERMINAL, 0.5 PITCH (4 X 4 X 1)	DOCUMENT NO: 98ARL10577D	REV: B
	CASE NUMBER: 1508-02	28 DEC 2005
	STANDARD: NON-JEDEC	


**EP (Pb-FREE) SUFFIX**  
24-LEAD QFN  
98ARL10577D  
ISSUE B



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TITLE: THERMALLY ENHANCED QUAD FLAT NON-LEADED PACKAGE (QFN) 24 TERMINAL, 0.5 PITCH (4 X 4 X 1)	DOCUMENT NO: 98ARL10577D		REV: B
	CASE NUMBER: 1508-02		28 DEC 2005
	STANDARD: NON-JEDEC		

**EP (Pb-FREE) SUFFIX**  
24-LEAD QFN  
98ARL10577D  
ISSUE B

NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. THE COMPLETE JEDEC DESIGNATOR FOR THIS PACKAGE IS: HF-PQFN.
4.  COPLANARITY APPLIES TO LEADS AND DIE ATTACH PAD.
5. MIN. METAL GAP SHOULD BE 0.2MM.

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TITLE: THERMALLY ENHANCED QUAD FLAT NON-LEADED PACKAGE (QFN) 24 TERMINAL, 0.5 PITCH (4 X 4 X 1)		DOCUMENT NO: 98ARL10577D		REV: B	
		CASE NUMBER: 1508-02		28 DEC 2005	
		STANDARD: NON-JEDEC			

**EP (Pb-FREE) SUFFIX**  
24-LEAD QFN  
98ARLA10577D  
ISSUE B

## REVISION HISTORY

REVISION	DATE	DESCRIPTION OF CHANGES
2.0	9/2005	Implemented Revision History page Converted to Freescale format
3.0	2/2008	Corrected Table 2, Pin Definitions on page 4.
4.0	5/2009	Corrected Note 7, in Static Electrical Characteristics table.
5.0	10/2013	Updated package drawings Corrected ordering information table to MPC17531ATEP and MPC17531ATEV/EL Added new back page and document properties
6.0	10/2013	Corrected packaing information on page 1



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